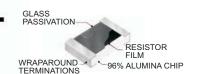
State of the Art, Inc. 2512 High Voltage Chip Resistor Thick Film, Solderable, Surface Mount Resistor



PERFORMANCE CHARACTERISTICS

ENVIRONMENTAL PERFORMANCE (2)

 Thermal Shock
 ±0.03%

 Low Temperature Operation
 ±0.03%

 Short-time Overload
 ±0.03%

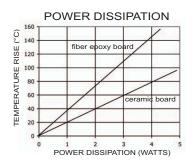
 Resistance to Bonding Exposure
 ±0.03%

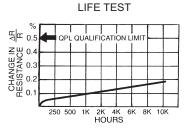
 Moisture Resistance
 ±0.05%

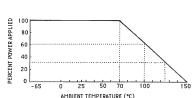
 High Temperature Exposure
 ±0.05%

 Life Test
 See Chart

(2)Typical resistance change, test methods and criteria per MIL-PRF-55342.







POWER DERATING

PART NUMBERING

S2512CVX1006F30 -TR

PACKAGING CODE: - TR = Tape/Reel - W = Waffle Carrier (Default packaging is Bulk)

TEMPERATURE CHARACTERISTIC: 10: ±100 ppm 20: ±200 ppm 30: ±300 ppm

TOLERANCE: F: 1% G: 2% J: 5% K: 10% M: 20%

RESISTANCE VALUE:

Four digits are used for tolerances of 1% or lower, three digits are used above 1%. Leading digits are significant while the last digit specifies the number of zeros to add. The letter "R" is used to represent the decimal for fractional ohmic values. Example: 5R6 is 5.6 ohms.

TERMINATION FINISH: X: SN60 (40% Pb) Solder Over Nickel Barrier, Y: Silver Over Nickel Barrier (RoHS)

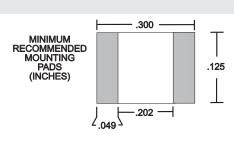
PRODUCT DESIGNATION: V: High Voltage
TERMINATION TYPE: C: Wraparound termination

SIZE CODE

GRADE: S: Standard Production H: High Reliability (For Screening options, contact the factory)

MECHANICAL

INCHES MILLIMETERS .250 (.250 - .258) 6.35 Length Width (6.35 - 6.55).119 (.119 - .125) 3.02 .028 (.023 - .033) 0.71 ໄ3.02 - 3.18ໂ Thickness (0.58 - 0.84) .020 (.015 - .025) 0.51 .019 (.015 - .025) 0.48 .212 (.208 - .216) 5.39 Top Term (0.38 - 0.64)**Bottom Term** (0.38 - 0.64)(5.28 - 5.49) Gap Approx. Weight .0513 grams



"Specifications subject to change without notice."